

T12M5T-B SERIES

Sensitive Gate Triacs Sillicon Bidirectional Thyristors

TRIACS 12 AMPERES RMS 600 VOLTS

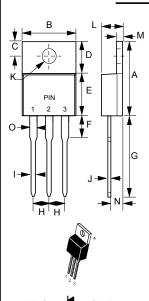
FEATURES

- Sensitive Gate Allows Triggering by Microcontrollers and other
- Blocking Voltage to 600 Volts
- High Surge Current Capability 90 Amperes
- Glass Passivated Junctions for Reliability and Uniformity
- Maximum Values of IGT, VGT and IH Specified for Ease of Design
- Operational in Three Quadrants: Q1, Q2, and Q3
- Pb Free Package

MECHANICAL DATA

• Case: Molded plastic

• Weight: 0.07 ounces, 2.0 grams



TO-220AB TO-220AB MIN. MAX. DIM. 14.22 15.88 9.65 10.67 2.54 3.43 5.84 6.86 8.26 9.28 6.35 12.70 14.73 2.29 2.79 0.51 1.14 0.40 0.67 3.53ø 4.09 Ø 4.83 3.56 M 1.14 1.40 Ν 2.03 2.92 1.17 1.37 All Dimensions in millimeter

PIN ASSIGNMENT			
1 Main Terminal 1			
2 Main Terminal 2			
3 Gate			
4 Main Terminal 2			

REV. 3, Mar-2010, KTXC23

MAXIMUM RATINGS (Tj= 25° unless otherwise noticed)

Rating	Symbol	Value	Unit
Peak Repetitive Off– State Voltage (1) (TJ= -40 to 110°C, Sine Wave, 50 to 60 Hz; Gate Open) T12M5T600B	VDRM, VRRM	600	Volts
On-State RMS Current (Full Cycle Sine Wave 50 to 60 Hz, Tc =70℃)	IT(RMS)	12	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, TJ= 25℃)	Ітѕм	90	Amps
Circuit Fusing Consideration (t = 8.3 ms)	l't	33	A ² s
Peak Gate Power (Tc = 70°C, Tp≦ 1.0 us)	Рсм	16	Watt
Average Gate Power (Tc = 70°C, t = 8.3 ms)	PG(AV)	0.35	Watt
Operating Junction Temperature Range	TJ	-40 to +110	$^{\circ}$
Storage Temperature Range	Tstg	-40 to +150	°C

Notice: (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



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Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case - Junction to Ambient	RthJC RthJA	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	$^{\circ}$ C

ELECTRICAL CHARACTERISTICS (TJ=25°C unless otherwise noted; Electrical apply in both directions)

Characteristics	Symbol	Min	Тур	Max	Unit
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OFF CHARACTERISTICS

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Peak Reptitive Forward or Reverse Blocking Current	TJ=25°C	IDRM	 	10	uA	ĺ
(VD=Rated VDRM, VRRM; Gate Open)	TJ=110℃	IRRM	 	2.0	mA	ĺ
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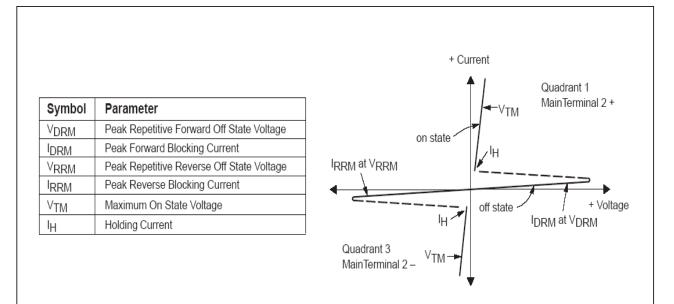
ON CHARACTERISTICS

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Peak On-State Voltage (ITM= \pm 17A Peak @Tp \leq 2.0 ms, Duty Cycle \leq 2%)	Vтм			1.85	Volts
Gate Trigger Current (V _D = 12V; R _L = 100 Ohms)	IGT1 IGT2 IGT3		1.5 2.5 2.7	5.0 5.0 5.0	mA
Gate Trigger Voltage (V _D = 12 V; R _L =100 Ohms)	VGT1 VGT2 VGT3	0.45 0.45 0.45	0.68 0.62 0.67	1.5 1.5 1.5	Volts
Holding Current (V _D = 12 V, Initiating Current = ± 200 mA, Gate Open)	Ін		2.5	10	mA
Latching Current (V _D = 12 V, IG = 5 mA)	I L1 I L2 I L3		3.0 5.0 3.0	15 20 15	mA

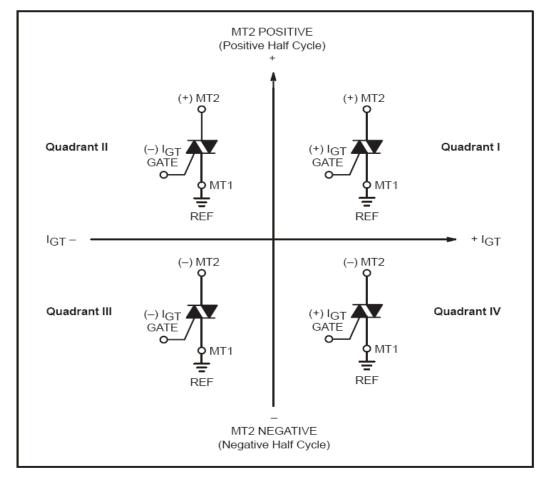
DYNAMIC CHARACTERISTICS

Rate of Change of Commutating Current (VD = 400 V, ITM = 3.5A, Commutating dv/dt = 10 V/us, Gate Open, TJ = 110° C, f = 500 Hz, Cs = 0.01 uF, Rs = 15 Ohms)	di/dt(c)	8.0	10		A/ms
Critical Rate of Rise of Off-State Voltage (VD = 67% Rated VDRM, Exponential Waveform, RGK=1K Ohms, TJ=110 $^{\circ}$ C)	dv/dt	15	40		V/us
Repetitive Critical Reat of Rise of On-State Current (IPK = 50A; PW = 40 usec; diG/dt = 1A/usec;lgt = 100mA; f= 60Hz)	di/dt			10	A/us





Quadrant Definitions



All polarities are referenced to MT1 Whith in -phase signal (using standard AC lines) quadrants I and III are used



